

Application Data Sheet
Application Information

Application type:: Regular
Subject matter:: Utility
CD-ROM or CD-R:: None
Number of CD disks:: None
Number of copies of CDs:: None
Sequence submission?::
Computer readable form (CRF)?:: No
Number of copies of CRF::
Title:: Integrated Circuit Package Structure
with Heat Dissipating Design
Attorney docket number:: CHAN32151EM
Request for early publication?:: No
Request for non-publication?:: No
Suggested drawing figure:: 3
Total drawing sheets:: 3
Small entity?:: No

Applicant Information

Applicant authority type:: Inventor
Primary citizenship country:: Taiwan, R.O.C.
Status:: Full capacity
Given name:: Nai-Shung
Middle name::
Family name:: CHANG
Name suffix::
City of Residence:: Shindian City, Taipei
State or province of residence::
Country of residence:: Taiwan, R.O.C.

Street of mailing address:: 8Fl., No. 533, Jungjeng Rd.
City of mailing address:: Shindian City, Taipei
State or province of mailing address::
Country of mailing address:: Taiwan, R.O.C.
Postal or zip code of mailing address::

Correspondence Information

Correspondence customer number:: 23364
Phone number:: 703-683-0500
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E-mail address:: mail@baconthomas.com

Representative Information

Representative customer number:: 23364

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
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Foreign Priority Information

Country::	Application number::	Filing Date::	Priority claimed::
Taiwan, R.O.C.	092100792	January 15, 2003	YES

Assignee Information

Assignee name:: VIA TECHNOLOGIES, INC.
Street of mailing address:: 8Fl., No.. 533, Jungjeng Rd.
City of mailing address:: Shindian City, Taipei
State or province of mailing address::
Country of mailing address:: Taiwan, R.O.C.
Postal or zip code of mailing address::